

Title (en)
IMPROVED SILVER PLATING METHOD AND ARTICLES MADE THEREFROM

Title (de)
VERBESSERTES VERSILBERUNGSVERFAHREN UND DAMIT ERZEUGTE ARTIKEL

Title (fr)
PROCEDE AMELIORE DE PLAQUAGE DE L'ARGENT, ET ARTICLES AINSI REALISES

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Application
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Abstract (en)
[origin: WO2004027113A2] An improved method for plating an organic substrate with silver is disclosed. Improved plating is achieved in part through the use of Na4EDTA, which facilitates improved grain formation and recovery of silver from waste material. Articles prepared using the method of the invention are also disclosed.

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